N- and P-Channel
Enhancement-Mode MOSFET Pair

Features

- ► Integrated GATE-to-SOURCE resistor
- ► Integrated GATE-to-SOURCE Zener diode
- ► Low threshold
- ► Low on-resistance
- ► Low input capacitance
- ► Fast switching speeds
- ► Free from secondary breakdown
- ► Low input and output leakage
- ► Independent, electrically isolated N- and P-channels

Applications

- ► High voltage pulsers
- ► Amplifiers
- ► Buffers
- ► Piezoelectric transducer drivers
- ► General purpose line drivers
- ► Logic level interfaces

General Description

The Supertex TC6320 consists of high voltage, low threshold N-channel and P-channel MOSFETs in 8-Lead SOIC and DFN packages. Both MOSFETs have integrated GATE-to-SOURCE resistors and GATE-to-SOURCE Zener diode clamps which are desired for high voltage pulser applications. It is a complimentary, high-speed, high voltage, GATE-clamped N- and P-channel MOSFET pair, which utilizes an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Typical Application Circuit

**Supertex
MD12xx, MD17xx, or MD18xx**

**Supertex
TC6320**
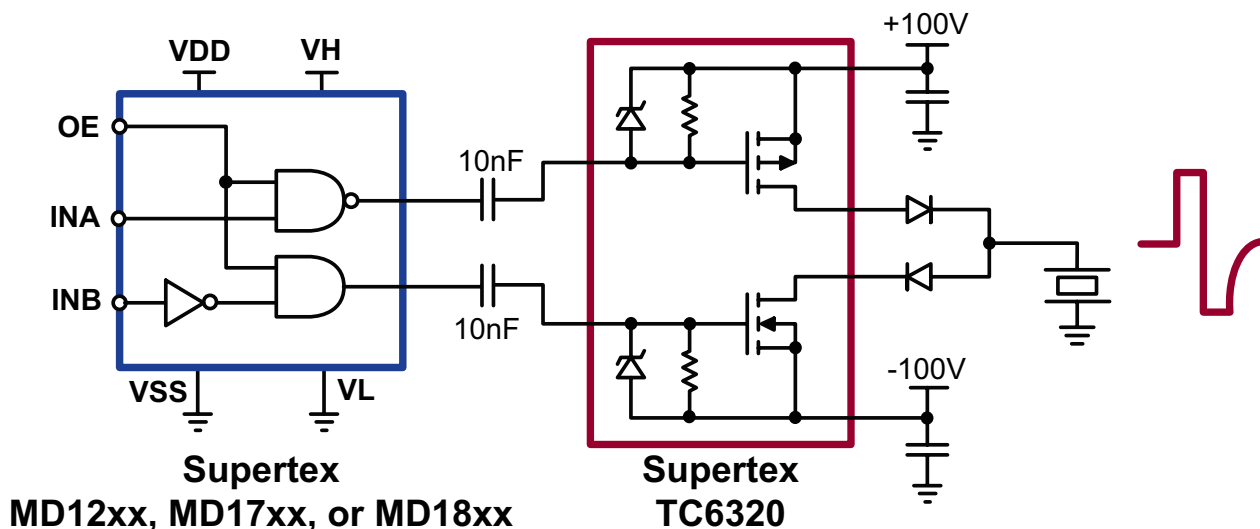
Ordering Information

Part Number	Package Option	Packing
TC6320K6-G	8-Lead DFN (4x4)	3000/Reel
TC6320TG-G	8-Lead SOIC	2000/Reel

-G indicates package is RoHS compliant ('Green')

Product Summary

BV_{DSS}/BV_{DGS} (V)		$R_{DS(ON)}$ (max) (Ω)	
N-Channel	P-Channel	N-Channel	P-Channel
200	-200	7.0	8.0

Absolute Maximum Ratings

Parameter	Value
DRAIN-to-SOURCE voltage	BV_{DSS}
DRAIN-to-GATE voltage	BV_{DGS}
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.
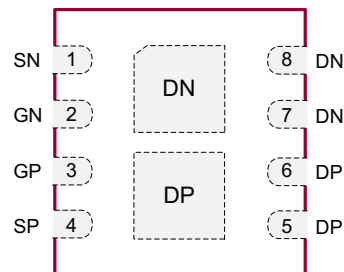
Typical Thermal Resistance

Package	θ_{ja}
8-Lead DFN	44°C/W
8-Lead SOIC	101°C/W

Note:
   1.0oz, 4-layer, 3"x4" PCB

Pin Configurations

8-Lead DFN
(top view)
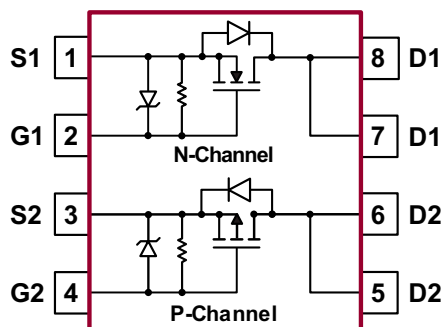
8-Lead SOIC
(top view)

Package Marking

Y = Last Digit of Year Sealed
W = Code for Week Sealed
L = Lot Number
____ = "Green" Packaging

Package may or may not include the following marks: Si or 🌀

8-Lead DFN

YY = Year Sealed
WW = Week Sealed
L = Lot Number
____ = "Green" Packaging

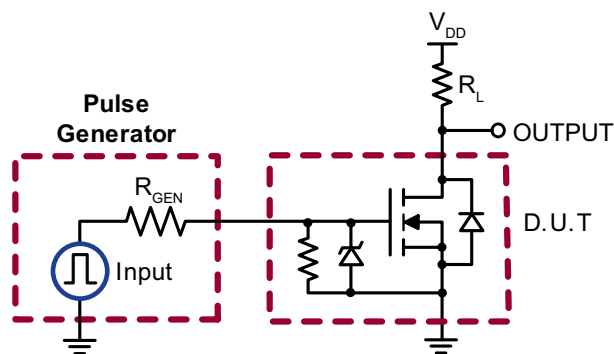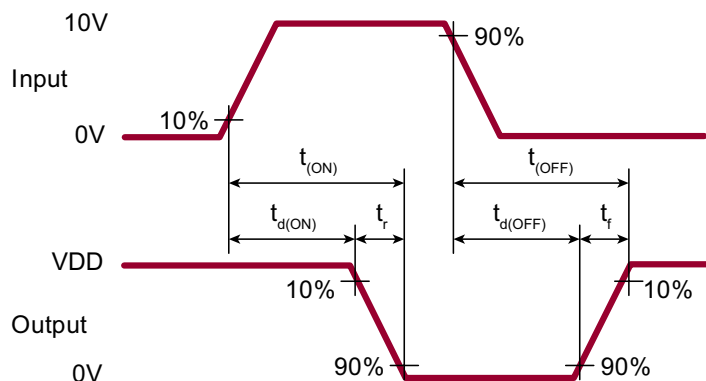*Package may or may not include the following marks: Si or* 🌀

8-Lead SOIC

N-Channel Electrical Characteristics *(T$_C$ = 25°C unless otherwise specified)*

Sym	Parameter	Min	Typ	Max	Units	Conditions
BV$_{DSS}$	DRAIN-to-SOURCE breakdown voltage	200	-	-	V	V$_{GS}$ = 0V, I$_D$ = 2.0mA
V$_{GS(th)}$	GATE threshold voltage	1.0	-	2.0	V	V$_{GS}$ = V$_{DS}$, I$_D$ = 1.0mA
ΔV$_{GS(th)}$	Change in V$_{GS(th)}$ with temperature	-	-	-4.5	mV/°C	V$_{GS}$ = V$_{DS}$, I$_D$ = 1.0mA
R$_{GS}$	GATE-to-SOURCE shunt resistor	10	-	50	kΩ	I$_{GS}$ = 100µA
VZ$_{GS}$	GATE-to-SOURCE Zener voltage	13.2	-	25	V	I$_{GS}$ = 2.0mA
I$_{DSS}$	Zero GATE voltage DRAIN current	-	-	10.0	µA	V$_{DS}$ = Max rating, V$_{GS}$ = 0V
		-	-	1.0	mA	V$_{DS}$ = 0.8 Max Rating, V$_{GS}$ = 0V, T$_A$ = 125°C
I$_{D(ON)}$	On-state DRAIN current	1.0	-	-	A	V$_{GS}$ = 4.5V, V$_{DS}$ = 25V
		2.0	-	-		V$_{GS}$ = 10V, V$_{DS}$ = 25V
R$_{DS(ON)}$	Static DRAIN-to-SOURCE on-state resistance	-	-	8.0	Ω	V$_{GS}$ = 4.5V, I$_D$ = 150mA
		-	-	7.0		V$_{GS}$ = 10V, I$_D$ = 1.0A
ΔR$_{DS(ON)}$	Change in R$_{DS(ON)}$ with temperature	-	-	1.0	%/°C	V$_{GS}$ = 4.5V, I$_D$ =150mA
G$_{FS}$	Forward transconductance	400	-	-	mmho	V$_{DS}$ = 25V, I$_D$ = 500mA
C$_{ISS}$	Input capacitance	-	-	110	pF	V$_{GS}$ = 0V, V$_{DS}$ = 25V, f = 1.0MHz
C$_{OSS}$	Common SOURCE output capacitance	-	-	60		
C$_{RSS}$	Reverse transfer capacitance	-	-	23		
t$_{d(ON)}$	Turn-on delay time	-	-	10	ns	V$_{DD}$ =25V, I$_D$ = 1.0A, R$_{GEN}$ = 25Ω
t$_r$	Rise time	-	-	15		
t$_{d(OFF)}$	Turn-off delay time	-	-	20		
t$_f$	Fall time	-	-	15		
V$_{SD}$	Diode forward voltage drop	-	-	1.8	V	V$_{GS}$ = 0V, I$_{SD}$ = 500mA
t$_{rr}$	Reverse recovery time	-	300	-	ns	V$_{GS}$ = 0V, I$_{SD}$ = 500mA

Notes:

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

## N-Channel Switching Waveforms and Test Circuit

P-Channel Electrical Characteristics *(T$_C$ = 25°C unless otherwise specified)*

| Sym	Parameter	Min	Typ	Max	Units	Conditions
BV$_{DSS}$	DRAIN-to-SOURCE breakdown voltage	-200	-	-	V	V$_{GS}$ = 0V, I$_D$ = -2.0mA
V$_{GS(th)}$	GATE threshold voltage	-1.0	-	-2.4	V	V$_{GS}$ = V$_{DS}$, I$_D$ = -1.0mA
ΔV$_{GS(th)}$	Change in V$_{GS(th)}$ with temperature	-	-	4.5	mV/°C	V$_{GS}$ = V$_{DS}$, I$_D$ = -1.0mA
R$_{GS}$	GATE-to-SOURCE shunt resistor	10	-	50	kΩ	I$_{GS}$ = 100µA
VZ$_{GS}$	GATE-to-SOURCE Zener voltage	13.2	-	25	V	I$_{GS}$ = -2mA
I$_{DSS}$	Zero GATE voltage DRAIN current	-	-	-10	µA	V$_{DS}$ = Max rating, V$_{GS}$ = 0V
		-	-	-1.0	mA	V$_{DS}$ = 0.8 Max Rating, V$_{GS}$ = 0V, T$_A$ = 125°C
I$_{D(ON)}$	On-state DRAIN current	-1.0	-	-	A	V$_{GS}$ = -4.5V, V$_{DS}$ = -25V
		-2.0	-	-		V$_{GS}$ = -10V, V$_{DS}$ = -25V
R$_{DS(ON)}$	Static DRAIN-to-SOURCE on-state resistance	-	-	10	Ω	V$_{GS}$ = -4.5V, I$_D$ = -150mA
		-	-	8.0		V$_{GS}$ = -10V, I$_D$ = -1.0A
ΔR$_{DS(ON)}$	Change in R$_{DS(ON)}$ with temperature	-	-	1.0	%/°C	V$_{GS}$ = -10V, I$_D$ =-200mA
G$_{FS}$	Forward transconductance	400	-	-	mmho	V$_{DS}$ = -25V, I$_D$ = -500mA
C$_{ISS}$	Input capacitance	-	-	200	pF	V$_{GS}$ = 0V, V$_{DS}$ = -25V, f = 1.0MHz
C$_{OSS}$	Common SOURCE output capacitance	-	-	55		
C$_{RSS}$	Reverse transfer capacitance	-	-	30		
t$_{d(ON)}$	Turn-on delay time	-	-	10	ns	V$_{DD}$ = -25V, I$_D$ = -1.0A, R$_{GEN}$ = 25Ω
t$_r$	Rise time	-	-	15		
t$_{d(OFF)}$	Turn-off delay time	-	-	20		
t$_f$	Fall time	-	-	15		
V$_{SD}$	Diode forward voltage drop	-	-	-1.8	V	V$_{GS}$ = 0V, I$_{SD}$ = -500mA
t$_{rr}$	Reverse recovery time	-	300	-	ns	V$_{GS}$ = 0V, I$_{SD}$ = -500mA

Notes:
1. *All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)*
2. *All A.C. parameters sample tested.*
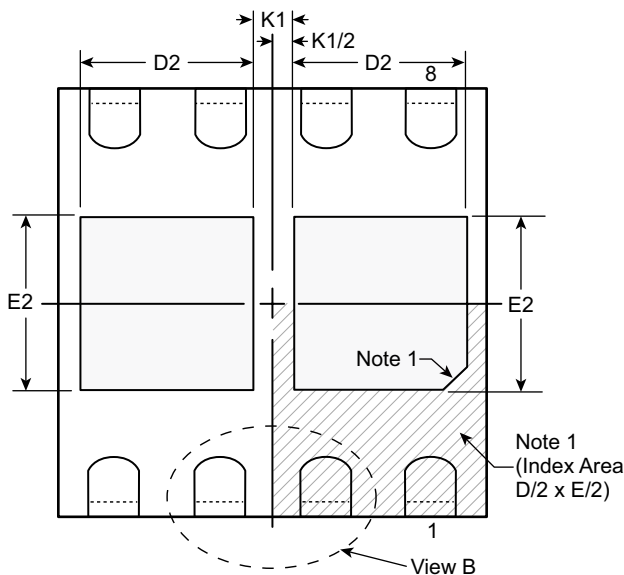
P-Channel Switching Waveforms and Test Circuit
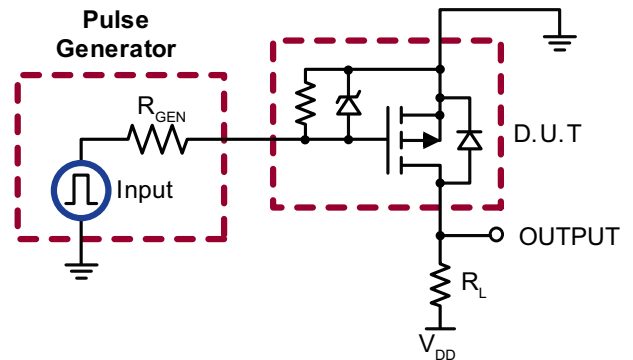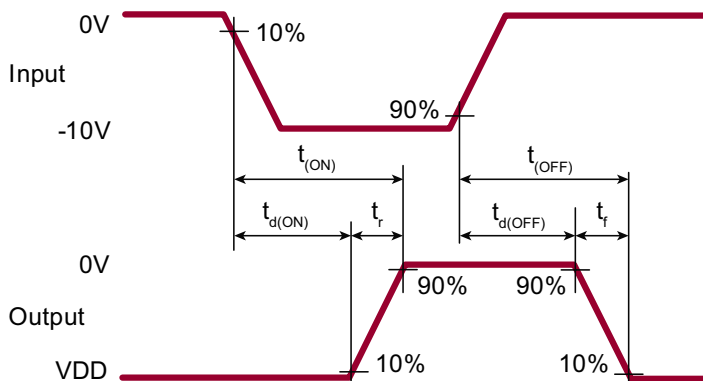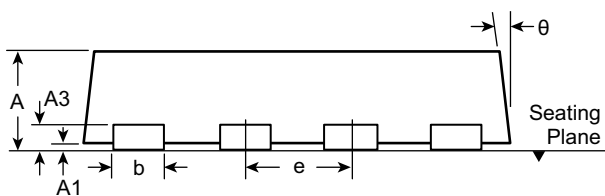
8-Lead DFN Package Outline (K6)
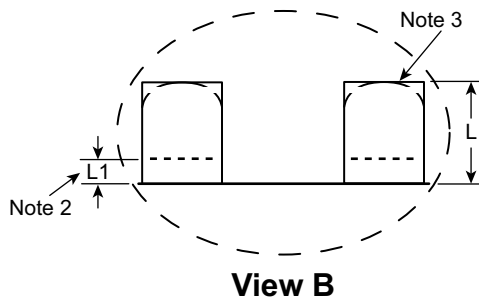## *4.00x4.00mm body, 1.00mm height (max), 1.00mm pitch (dual pad)*
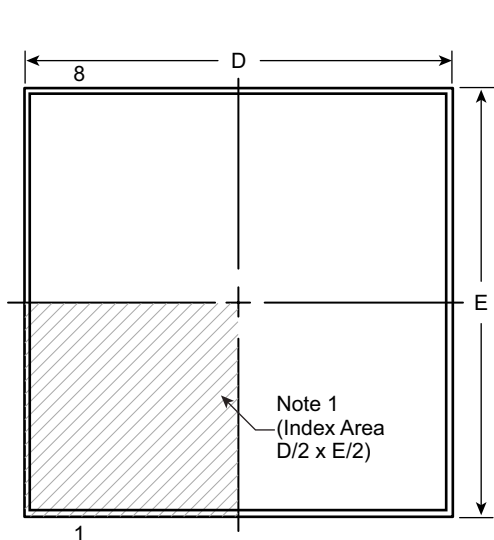
Top View

Bottom View

Side View

View B

Notes:

1. *A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.*
2. *Depending on the method of manufacturing, a maximum of 0.15mm pullback (L1) may be present.*
3. *The inner tip of the lead may be either rounded or square.*

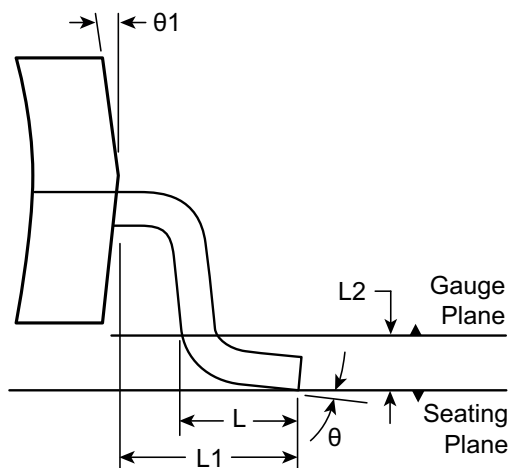| Symbol		A	A1	A3	b	D	D2	E	E2	e	K1	L	L1	θ
Dimension (mm)	MIN	0.80	0.00	0.20 REF	0.25	3.90	1.35	3.90	1.35	1.00 BSC	0.50 REF	0.40	0.00	0º
	NOM	0.90	-		0.30	4.00	1.45	4.00	1.45			0.50	-	-
	MAX	1.00	0.05		0.35	4.10	1.55	4.10	1.55			0.60	0.15	14º

Drawings not to scale
Supertex Doc. #: *DSPD-8DFNK64x4P100, Version C010813*
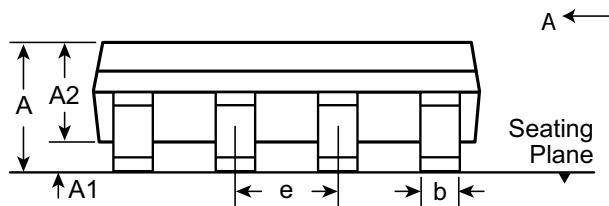
8-Lead SOIC (Narrow Body) Package Outline (TG)
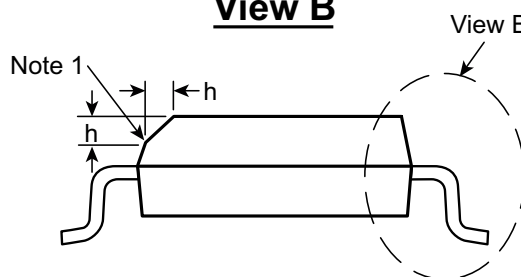## *4.90x3.90mm body, 1.75mm height (max), 1.27mm pitch*
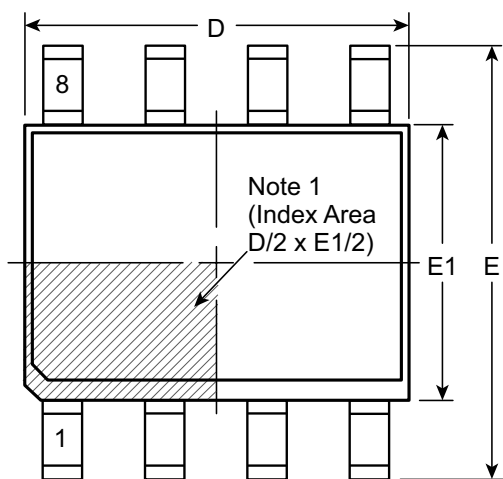
Top View

View B

Side View

View A-A

Note:

1. *This chamfer feature is optional. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.*

Symbol		A	A1	A2	b	D	E	E1	e	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	1.35*	0.10	1.25	0.31	4.80*	5.80*	3.80*	1.27 BSC	0.25	0.40	1.04 REF	0.25 BSC	0°	5°
	NOM	-	-	-	-	4.90	6.00	3.90		-	-			-	-
	MAX	1.75	0.25	1.65*	0.51	5.00*	6.20*	4.00*		0.50	1.27			8°	15°

JEDEC Registration MS-012, Variation AA, Issue E, Sept. 2005.
* This dimension is not specified in the JEDEC drawing.
Drawings are not to scale.
***Supertex Doc. #:** DSPD-8SOLGTG, Version I041309.*

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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